PHOTOLUMINESCENCE STUDIES OF GaN AND AlGaN LAYERS UNDER HYDROSTATIC PRESSURE

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Abstract

Wide bandgap GaN very often shows a high electron concentration. Although several impurities such as O and Si have been identified, the concentration is not high enough to account for the number of free carriers. As a consequence native defects namely the nitrogen vacancies are widely considered to be present at high densities. Several calculations predict different energy levels of this strongly localized defect. We present photoluminescence experiments of wurtzite GaN and AlGaN layers under large hydrostatic pressure to search for localized defects within the questionable energy range of 3.0 to 3.8 eV above the valence band edge.

Introduction

The growing interest in GaN and the wide bandgap III-V nitrides is driven by the recent demonstration of UV and blue light emitting devices [1]. This success has been achieved by a continuous basic research effort over the last few decades. Although promising device performances have been obtained, a great amount of details of the electronic and defect structure are still not understood. As observed in GaN material grown by many different techniques, it is very often highly n-type conducting in the range of 10^{18} - 10^{20} cm⁻³ [2]. However no impurities could be observed or identified by any technique at that high concentration. Secondary ion mass spectroscopy (SIMS) results indeed reveal incorporation of O or Si and both of those elements should act as a donor in GaN [3,4], yet concentration typically ranges about two orders of magnitude below the observed carrier concentration in highly conducting material [5-8]. Based on the presently available data, impurities can not be the major source of dopants in GaN. Consequently native defects are considered to be present in very high concentrations.

Calculations by several groups predict the charge states and the energy levels of native defects [9-11]. At present only isolated defects rather than complexes have been considered, and among group III vacancies, group V vacancies and antisites the nitrogen vacancy V_N is the best candidate to act as a donor. From several stoichiometry considerations this candidate has been

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favored in many publications [12,13]. However no experimental evidence of the existence of this defect could be given so far. The model of Jenkins et al. [9] predict two levels A_1 and T_2 of the neutral V_N to lie close to the conduction band (CB). A_1 should be filled with two electrons and lie ~ 0.2 eV below CB whereas T_2 should carry one out of six electrons and lie ~ 0.6 eV above the CB. Being resonant with the CB the electron would auto-ionize, thermalize to the band edge and finally be bound in a hydrogenic state of the remaining fixed positive charge. Boguslawski et al. [10] predict both of those levels to lie within the CB, A_1 at $E_{CB} + 0.8$ eV, T_2 at $E_{CB} + 1.3$ eV. In a third calculation by Neugebauer and Van de Walle [11] existence of the resonant level T_2 has been confirmed, in contrast to the other predictions the A_1 level should lie within the valence band and should not contribute as a donor level. Interestingly a calculation of the formation energy in the same work denies the possibility of formation of high isolated V_N concentrations unless the material is highly p-type.

Here we present a photoluminescence study of autodoped highly conducting AlGa_N and GaN layers applying large hydrostatic pressure in search for the possible level of V_N in the region of 3.0 to 3.8 eV. Being a strongly localized defect the energy levels of the V_N should be independent to a high degree from the energetic position of the band edges. Shifting the band edge by alloying, e.g. in AlGa_N, or under hydrostatic pressure would then separate hydrogenic levels from levels of strongly localized defects. Such a behavior has been observed for several defects, e.g. in AlGaAs [14].

Experimental

Nominally undoped Al_{0.15}Ga_{0.85}N/GaN/sapphire heterostructure samples were grown by atmospheric pressure MOCVD using the technique of low temperature AlN buffer layers [15]. Layer thickness was 2 μ m (GaN) and 1 μ m (AlGa_N). Low temperature (6K) PL was excited by a 10 mW, 325 nm line of a HeCd laser, dispersed by a 1 m double monochromator (SPEX) and detected by a UV sensitive photomultiplier tube using lock-in detection. Hydrostatic pressure was applied by means of a Merrill-Bassett type diamond anvil cell using the fluorescence of R₁ ruby lines at 6 K as secondary standard for the pressure determination [16].

Results

PL of the heterostructure at 0.7 GPa (a) and 3.4 GPa (b) in the vicinity of the bandgaps is presented in Fig. 1. Spectra are given for excitation from the AlGa_N layer side (full lines) and the substrate side (dashed lines) (refer to the CB schematic in the inset). Luminescence of the AlGa_N layer is blocked when excited from the substrate side and only a signal from the GaN

Figure 1: PL excitation from the AlGaN side (full line) and through the substrate (dashed line) at 0.7 GPa (a) and 4.5 GPa (b).

layer is observed. Excitation from the top shows the shallow bound excitons of both of the layers and a defect related contribution on the lower edge of the spectrum. These defects are located in the AlGaN layer, as the luminescence can only be excited through the AlGaN band edge. There is a small separation of 6.7 meV (0.7 GPa) and 8.7 meV (3.4 GPa) in the excitonic luminescence of the GaN layer that corresponds to the band edge shift due to different bi-axial strain conditions on the lower and the upper GaN interfaces [17]. Both excitons show an asymmetric lineshape with an exponential tail to the low energy side. This is especially obvious on a logarithmic scale (Fig. 3). Besides strain effects this tail width is very sensitive to the presence of a high density of defect states at this energy. In photoluminescence an additional

very narrow line is observed in all spectra at 3.6466 eV and stems from a first order LO-Raman line of the HeCd laser in the diamonds of the pressure cell.

Figure 2: Infrared reflection of the heterostructures. The phonon-plasmon coupled modes reduce the reflection of the sapphire (dashed) reststrahlenband.

The high defect and carrier concentration in the individual layers of these films is confirmed by the infrared experiment in Fig. 2. Within the phonon region reflection is dominated by the reststrahlenband of the sapphire substrate with a high frequency edge at about 900 cm^{-1} . The

layers on top of this mirror-like substrate give rise to pronounced dips at the energies of the LO phonon-plasmon coupled modes in the individual layers. From the position and the line shape within an oscillator model of the dielectric function the carrier concentration is derived ($N = 1 \times 10^{18} - 2 \times 10^{18} \text{ cm}^{-3}$) using parameters of GaN [18].

According to the typical behavior of strongly localized defects a pressure dependence different from the band edges can be expected under hydrostatic pressure. Spectra are obtained from ambient pressure up to 7 GPa. The peak positions of the shallow bound excitons are collected in Fig. 4 (squares GaN, circles AlGaIn). Within our pressure range we find a linear shift of the exciton position with pressure.

$$\begin{aligned} dE/dp &= 43.7 \pm 1.0 \text{ meV/GPa in GaN} \\ &= 44.3 \pm 1.4 \text{ meV/GPa in Al}_{0.15}\text{Ga}_{0.85}\text{N}. \end{aligned}$$

For the ease of interpretation the spectra displayed in Fig. 2 on a logarithmic scale are corrected for the pressure shift of the GaN exciton. We thus realize that all features move parallel to the excitonic lines. The defect related features in the AlGaIn layer reveal a donor acceptor transition structure including several phonon replica. At higher pressure they are especially pronounced. The line width of the excitonic transitions shows only little change in the GaN layer (FWHM ~ 26 meV), in the AlGaIn layer it slightly increases up to ~ 35 meV at 4.6 GPa (marker B in Fig. 3). From the peak positions (Fig. 4) we derive a binding energy of the donor acceptor transition of 229 ± 7 meV with respect to the exciton or ~ 260 meV with respect to the band edge assuming an exciton binding energy of 30 meV. Phonon replica appear with energies of 85 to 96 meV in first and second order (see dotted lines in Fig. 4 parallel to excitonic shift).

Figure 3: PL on a logarithmic scale versus the energy shifted by the pressure increase of the GaN excitonic gap.

Figure 4: Peakposition of the excitonic transitions in AlGaIn (full circles) and GaN (full triangles). The dashed lines are the best linear fit. The defect related transitions are represented by open symbols. The dotted lines are guides for the eye parallel the excitonic shift. The full line is the result of Ref. [19].

clarify this point. Besides this feature we find no indication of strongly localized defects when shifting the excitons from 3.45 to 3.8 eV. We furthermore conclude that within the scope of our interpretation no strongly localized levels lie within the range of 3.45 to 3.7 eV above the respective valence band edge in our samples. In addition no strongly localized defect was observed in photoluminescence in the spectral range covered here down to 3.0 eV. It should be mentioned that other experiments indicate a crossing of the CB with a localized level at about 18 GPa [19] respective below 27 GPa [20].

Within the pressure range up to 7 GPa we find a linear dependence of the excitonic bandgap energies in GaN and $\text{Al}_{0.15}\text{Ga}_{0.85}\text{N}$. This is in contrast to available data from absorption in thick samples without substrate [21]. Up to pressures of 5.5 GPa a strong sublinear behavior was observed (drawn line in Fig. 4). Our findings might be related to the bi-axial strain present in our thin film structures as manifested in the GaN peak difference when looking from the top or the substrate side. Similar results are obtained on cubic GaN samples for $p \leq 5 \text{ GPa}$ [22].

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Discussion

From these experiments we conclude that all observed luminescence contributions in the AlGaIn/GaN heterostructure samples behave like hydrogenic defect levels. All spectral features in the heterostructure shift parallel to the band edges. There is a weak indication of a possible interaction with additional defect states in the AlGaIn excitonic luminescence at 4.6 GPa. However at 3.75 eV this line is close to the laser excitation and this could as well affect the line shape. Further investigations are necessary to

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